

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2595896

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>PETER MOENS</td> <td>10/04/2013</td> </tr> <tr> <td>ANA VILLAMOR</td> <td>10/21/2013</td> </tr> <tr> <td>PIET VANMEERBEEK</td> <td>10/03/2013</td> </tr> <tr> <td>JAUME ROIG-GUITART</td> <td>10/03/2013</td> </tr> <tr> <td>FILIP BOGMAN</td> <td>10/04/2013</td> </tr> </tbody> </table>		Name	Execution Date	PETER MOENS	10/04/2013	ANA VILLAMOR	10/21/2013	PIET VANMEERBEEK	10/03/2013	JAUME ROIG-GUITART	10/03/2013	FILIP BOGMAN	10/04/2013
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RECEIVING PARTY DATA													
Name:	SEMICONDUCTOR COMPONENTS INDUSTRIES, LLC												
Street Address:	5005 E. MCDOWELL RD.												
Internal Address:	A700												
City:	PHOENIX												
State/Country:	ARIZONA												
Postal Code:	85008												
PROPERTY NUMBERS Total: 1													
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14032454</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	14032454								
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Application Number:	14032454												
CORRESPONDENCE DATA													
Fax Number:	(602)244-3169												
Phone:	602-244-6648												
Email:	PATENTS@ONSEMI.COM												
<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>													
Correspondent Name:	SEMICONDUCTOR COMPONENTS INDUSTRIES, LLC												
Address Line 1:	5005 E. MCDOWELL ROAD, MAILDROP A700												
Address Line 4:	PHOENIX, ARIZONA 85008												
ATTORNEY DOCKET NUMBER:	ONS01549												
NAME OF SUBMITTER:	BECKY NEWNAM												

CH \$40.00 14032454

Signature:	/Becky Newnam/
Date:	10/29/2013
Total Attachments: 3 source=ONS01549_Assignment#page1.tif source=ONS01549_Assignment#page2.tif source=ONS01549_Assignment#page3.tif	

ASSIGNMENT & AGREEMENT

ONS01549

For good and valuable consideration, the receipt of which is hereby acknowledged, we,

<u>Name</u>	<u>of (City/State/Country)</u>
Peter Moens	Zottegem, Belgium
Ana Villamor	Barcelona, Spain
Piet Vanmeerbeek	Sleidinge, Belgium
Jaume Roig-Guitart	Oudenaarde, Belgium
Filip Bogman	Dendermonde, Belgium

have sold, assigned, and transferred, and do hereby sell, assign, and transfer unto Semiconductor Components Industries, LLC (SCI), a limited liability Company of the State of Delaware, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives, the entire right, title, and interest in and to certain inventions relating to improvements in

SEMICONDUCTOR DEVICE HAVING LOCALIZED CHARGE BALANCE STRUCTURE AND METHOD

Attorney Docket No. ONS01549

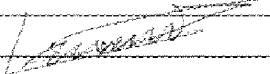
described, illustrated, and claimed in an application for Letters Patent of the United States of America executed by us, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation, or reissue thereof.


We hereby also sell, assign, and transfer unto SCI, the entire right, title, and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the inventions and the applications for Letters Patent in foreign countries, and we further authorize SCI to apply for Letters Patent in foreign countries directly in its own name, and to claim the priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation, or reissue, to SCI, for the sole use and behalf of SCI, its successors, assigns, and legal representatives, to the full end of the term for which the Letters Patent may be granted, the same as they would have been held and enjoyed by us had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to SCI.

We agree that, when requested, we will, without charge to SCI, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in SCI, its successors, assigns, and legal representatives or nominees.


We covenant with SCI, its successors, assigns, and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license, or other encumbrance.

By (Inventor signature): 
Peter Moens

Witnessed by (Witness signature): 

Printed name of Witness: TONY COLPAERT

Signed and Witnessed on (date): 4 OCTOBRE 2013

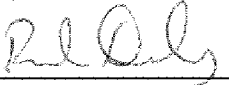
By (Inventor signature): 
Ana Villamor

Witnessed by (Witness signature): MITSURU Soma 相馬 亮

Printed name of Witness: MITSURU Soma

Signed and Witnessed on (date): 21.10.2013.

By (Inventor signature): 
Piet Vanmeerbeek

Witnessed by (Witness signature): 

Printed name of Witness: PAUL DACM

Signed and Witnessed on (date): 03 OCT 2013

ASSIGNMENT & AGREEMENT


ONS01549

By (Inventor signature): 
Jaume Roig-Guitart

Witnessed by (Witness signature): 

Printed name of Witness: CF TONG

Signed and Witnessed on (date): OCT-03-2013

By (Inventor signature): 
Filip Bogman

Witnessed by (Witness signature): 

Printed name of Witness: G. Koops

Signed and Witnessed on (date): 4th October. 2013